



0504-1048  
PATENT

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of:

Hao-Wen CHIU et al.

Conf.: 5884

Appl. No.: 10/015,587

Group: 1734

Filed: December 17, 2001

Examiner: Yewebdar Tadesse

MOLD AND A METHOD OF HOT-FORMING  
A THERMOPLASTIC LENS

AMENDMENT

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

April 26, 2004

Sir:

Responsive to the Official Action of March 24, 2004, please  
amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing  
of claims which begins on page 2 of this paper.

**Remarks** begin on page 10 of this paper.